概述

HSPX3819 系列是一组低压差 (LDO) 转换器,具有 2.8V 至 20V 宽电压输入范围、低压差、低功耗和小型化封装的等特性,输出电压范围为 3.0-5.0V。

HSPX3819 低至 1.8uA 低静态电流特性,电路也带有CE使能控制端口,可使电路进入休眠状态。特别适合用于电池供电、长时间待机系统设备应用,能帮助降低系统设备的待机功耗,有效延长待机时间和电池使用寿命。

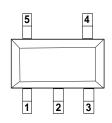
特点

- 输入输出电压差低
- 温度漂移系数小
- 耐压 20V
- 工作静态电流 1.8µA,最大 4µA
- 休眠静态电流最大 0.2µA
- 输出电压精度:±2%
- 输出过载保护
- 带有 CE 使能控制端口
- 工作温度 -20°C ~+105°C

应用场合

- 手持式、电池供电设备
- 通信设备
- 音频、视频设备
- 低功耗微处理器
- 笔记本电脑、掌上型电脑和 PDA
- 车载导航系统
- 工业控制
- 智能家居

封装脚位描述



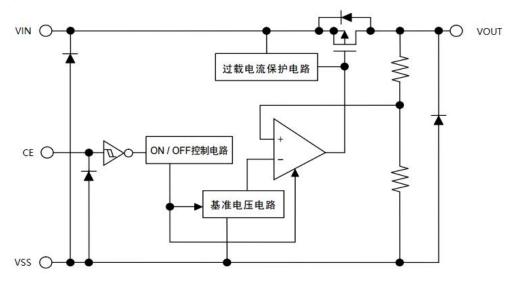
SOT-23-5L

PIN脚位	** H	.		
SOT-23-5L	符号	功能说明		
1	V _{IN}	电源输入端		
2	V_{SS}	地		
3	CE	使能端		
4	NC	悬空		
5	V _{OUT}	电源输出端		

型号介绍

型号 名	封装	输出电压	包装信息
HSPX3819M5-L-3-0/TR	SOT-23-5L	3.0V	3000/盘
HSPX3819M5-L-3-3/TR	SOT-23-5L	3.3V	3000/盘
HSPX3819M5-L-5-0/TR	SOT-23-5L	5.0V	3000/盘

典型应用图



绝对最大额定值

参数	符号	范围	单位
输入电压	V _{IN}	-0.3∼+22	V
输出电流	I _{OUT}	500	mA
输出电压	V_{OUT}	Vss-0.3∼V _{IN} +0.3	V
使能电压	V _{CE}	Vss-0.3∼V _{IN} +0.3	V
耗散功率	P _D	200	mW
工作温度范围	T _{OPR}	-40 ∼ +80	°C
存储温度范围	T _{STG}	-40∼+150	°C
焊接温度		260°C, 10sec	



电气参数(无特别说明情况下, TA=25℃, CiN=CouT=1uF)

参数说明	符号	测试条件	最小值	典型值	最大值	单位
输入电压	Vin		3.0		20	V
输出电压	Vouт		3.0		5.0	V
输出电压精度		louт=1mA	-2		+2	%
输出电流	Іоит	VIN=VOUT+2.0V		350		mA
负载调整率	∆Vоит	Vin=Vout+2.0V 1mA≤Iout≤150mA		15		mV
线性调整率	△Vουτ/ Vουτ*△Vin	Vout+1.0V≤Vin≤20V lout=10mA		0.015	0.2	%/V
低压差	$V_{DIF}^{\scriptscriptstyle{\textcircled{\scriptsize{1}}}}$	Іоит=100mA,Vоит=3.3V		200		mV
静态电流	Iss	Vce=Vin		1.8	4	μΑ
休眠电流	ISTANDBY	Vce=Vss			0.2	μΑ
使能高电平	Vсен	Vin=Vout+2.0V	1.7		24	V
使能低电平	Vcel	Vin=Vout+2.0V	0		0.3	V
短路电流	Ishort	VIN=VOUT+2.0V		400		mA
温度系数	△Vоит/ △Та*Vouт	Vin=Vout+2.0V Iout=10mA -40°C≤Ta≤125°C		±100		ppm/°C
输出有源放电电 阻	R _{DIS} [®]	VCE<0.5V		300		

注:

①当 VIN=VOUT+2.0V, 固定负载条件下使输出电压下降 2%, 此时输入电压和输出电压的差值为低压差值 VDIF。

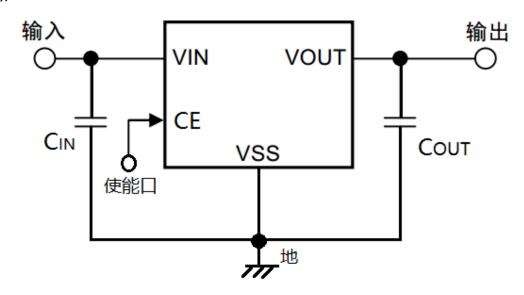
②输出有源放电电阻 RDIS,随着 VIN 电压增大而降低。



应用说明

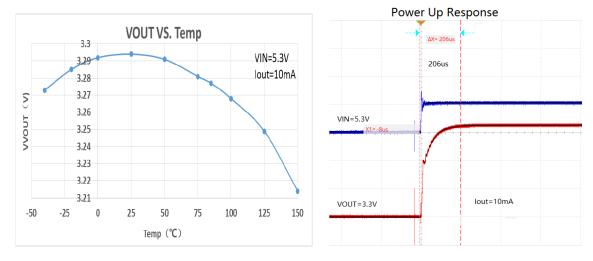
- 1、应用时尽量将电容接到 VIN 和 VOUT 脚位附近。
- 2、电路内部使用了相位补偿电路和利用输出电容的 ESR 来补偿。所以输出到地一定要接大于或者等于 1μF 的电容器。
- 3、注意输入输出电压、负载电流的使用条件,避免 IC 内部的功耗超出封装允许的最大功耗值。

应用电路



- 1.C_№用于稳定输入电容
- 2.C_{оит}可以使用的大于或等于1µF的陶瓷电容

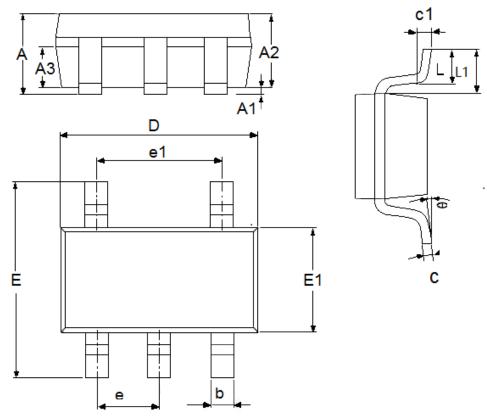
特性曲线





封装信息

• SOT-23-5L



参数	尺寸 (mm)		尺寸 (Inch)		
	最小值	最大值	最小值	最大值	
Α	1.05	1.45	0.0413	0.0571	
A1	0	0.15	0.0000	0.0059	
A2	0.9	1.3	0.0354	0.0512	
A3	0.6	0.7	0.0236	0.0276	
b	0.25	0.5	0.0098	0.0197	
С	0.1	0.23	0.0039	0.0091	
D	2.82	3.05	0.1110	0.1201	
e1	1.9(TYP)		0.0748(TYP)		
Е	2.6	3.05	0.1024	0.1201	
E1	1.5	1.75	0.0512	0.0689	
е	0.95(TYP)		0.0374(TYP)		
L	0.25	0.6	0.0098	0.0236	
L1	0.59(TYP)		0.0232(TYP)		
θ	0	8°	0.0000	8°	
c1	0.2(TYP)		0.0079(TYP)		



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